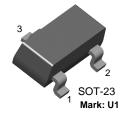


BCX19

NPN Medium Power Transistor

- This device is designed for general purpose amplifiers.
- Sourced from process 38.



1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

| Symbol | Parameter | Value | Units |
|-----------------------------------|----------------------------------|------------|-------|
| V_{CEO} | Collector-Emitter Voltage | 45 | V |
| V _{CBO} | Collector-Base Voltage | 50 | V |
| V _{EBO} | Emitter-Base Voltage | 5.0 | V |
| I _C | Collector current - Continuous | 500 | mW |
| T _J , T _{stg} | Junction and Storage Temperature | -55 ~ +150 | °C |

Electrical Characteristics $T_C=25$ °C unless otherwise noted

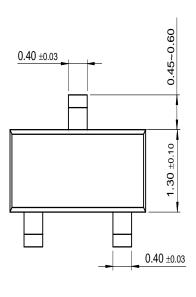
| Symbol | Parameter | Test Condition | Min. | Тур. | Max. | Units |
|----------------------|--------------------------------------|--|-----------------|------|------------|----------|
| Off Characte | eristics | • | | | | |
| V _{(BR)CEO} | Collector-Emitter Breakdown Voltage | $I_C = 10 \text{mA}, I_B = 0$ | 45 | | | V |
| V _{(BR)CES} | Collector-Emitter Breakdown Voltage | $I_C = 10\mu A, I_C = 0$ | 50 | | | V |
| I _{CBO} | Collector Cutoff Current | $V_{CB} = 20V, I_{E} = 0$ $V_{CB} = 20V, I_{E} = 0, T_{A} = 150^{\circ}C$ | | | 100 5.0 | nA μA |
| I _{EBO} | Emitter Cutoff Current | $V_{EB} = 5.0V, I_{C} = 0$ | | | 10 | μΑ |
| On Characte | eristics | • | • | • | | • |
| h _{FE} | DC Current Gain | I _C = 100mA, V _{CE} = 1.0V I _C = 300mA, V _{CE} = 1.0V I _C = 500mA, V _{CE} = 1.0V | 100 70 40 | | 600 | |
| V _{CE(sat)} | Collector-Emitter Saturation Voltage | I _C = 500mA, I _B = 50mA | | | 0.62 | V |
| V _{BE(on)} | Base-Emitter On Voltage | I _C = 500mA, V _{CE} = 1.0V | | | 1.2 | V |

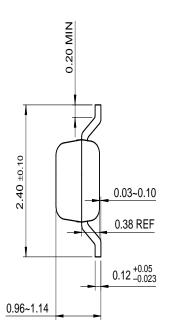
Thermal Characteristics T_A=25°C unless otherwise noted

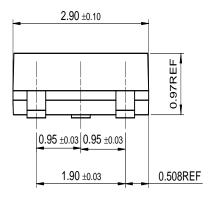
| Symbol | Parameter | Max. | Units | |
|----------------|---|------|-------|--|
| P _D | Total Device Dissipation | 300 | mW | |
| | Derate above 25°C | 2.4 | mW/°C | |
| $R_{	hetaJA}$ | Thermal Resistance, Junction to Ambient | 417 | °C/W | |

Package Dimensions

SOT-23







Dimensions in Millimeters

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| EnSigna™ | I^2C^{TM} | OCX^{TM} | RapidConfigure™ | UHC™ |
| Across the board. | . Around the world.™ | OCXPro™ | RapidConnect™ | UltraFET [®] |
| The Power Franchise™ | | OPTOLOGIC [®] | SILENT SWITCHER® | VCX^{TM} |
| Programmable Ad | ctive Droop™ | OPTOPLANAR™ | SMART START™ | |

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|--------------------------|---------------------------|---|
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